



ALPHA & OMEGA
SEMICONDUCTOR

AOT5N100/AOTF5N100

1000V, 4A N-Channel MOSFET

General Description

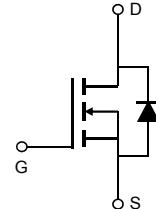
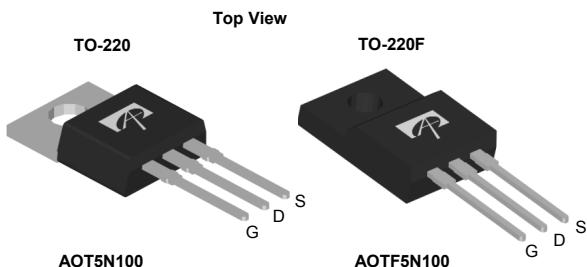
The AOT5N100 & AOTF5N100 are fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{DS(on)}$, C_{iss} and C_{rss} along with guaranteed avalanche capability this parts can be adopted quickly into new and existing offline power supply designs.

For Halogen Free add "L" suffix to part number:
AOT5N100L & AOTF5N100L

Product Summary

| | |
|---------------------------------|------------|
| V_{DS} | 1100@150°C |
| I_D (at $V_{GS}=10V$) | 4A |
| $R_{DS(ON)}$ (at $V_{GS}=10V$) | < 4.2Ω |

100% UIS Tested
100% R_g Tested



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter | Symbol | AOT5N100 | AOTF5N100 | Units |
|--|----------------|------------|-----------|-------|
| Drain-Source Voltage | V_{DS} | 1000 | | V |
| Gate-Source Voltage | V_{GS} | ± 30 | | V |
| Continuous Drain Current <small>$T_C=25^\circ C$</small> | I_D | 4 | 4* | A |
| | | 2.5 | 2.5* | |
| Pulsed Drain Current ^C | I_{DM} | 15 | | |
| Avalanche Current ^C | I_{AR} | 2.8 | | A |
| Repetitive avalanche energy ^C | E_{AR} | 117 | | mJ |
| Single pulsed avalanche energy ^G | E_{AS} | 235 | | mJ |
| Peak diode recovery dv/dt | dv/dt | 5 | | V/ns |
| Power Dissipation ^B <small>$T_C=25^\circ C$</small> | P_D | 195 | 42 | W |
| | | 1.6 | 0.3 | W/ °C |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | | °C |
| Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds | T_L | 300 | | °C |

Thermal Characteristics

| Parameter | Symbol | AOT5N100 | AOTF5N100 | Units |
|--|-----------------|----------|-----------|-------|
| Maximum Junction-to-Ambient ^{A,D} | $R_{\theta JA}$ | 65 | 65 | °C/W |
| Maximum Case-to-sink ^A | $R_{\theta CS}$ | 0.5 | -- | °C/W |
| Maximum Junction-to-Case | $R_{\theta JC}$ | 0.64 | 3 | °C/W |

* Drain current limited by maximum junction temperature.

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|------------------------------------|---|--|------|------|------|-------|
| STATIC PARAMETERS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | I _D =250μA, V _{GS} =0V, T _J =25°C | 1000 | | | V |
| | | I _D =250μA, V _{GS} =0V, T _J =150°C | | 1100 | | |
| BV _{DSS} /ΔT _J | Breakdown Voltage Temperature Coefficient | I _D =250μA, V _{GS} =0V | | 1.04 | | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =1000V, V _{GS} =0V | | | 1 | μA |
| | | V _{DS} =800V, T _J =125°C | | | 10 | |
| I _{GSS} | Gate-Body leakage current | V _{DS} =0V, V _{GS} =±30V | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =5V, I _D =250μA | 3.3 | 3.9 | 4.5 | V |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =2.5A | | 3.5 | 4.2 | Ω |
| g _{FS} | Forward Transconductance | V _{DS} =40V, I _D =2.5A | | 5 | | S |
| V _{SD} | Diode Forward Voltage | I _S =1A, V _{GS} =0V | | 0.73 | 1 | V |
| I _S | Maximum Body-Diode Continuous Current | | | | 4 | A |
| I _{SM} | Maximum Body-Diode Pulsed Current | | | | 15 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =25V, f=1MHz | 750 | 950 | 1150 | pF |
| C _{oss} | Output Capacitance | | 40 | 62 | 85 | pF |
| C _{rss} | Reverse Transfer Capacitance | | 3.5 | 6 | 9 | pF |
| R _g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1MHz | 2 | 4.3 | 6.5 | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q _g | Total Gate Charge | V _{GS} =10V, V _{DS} =800V, I _D =5A | 15 | 19 | 23 | nC |
| Q _{gs} | Gate Source Charge | | | 4.6 | | nC |
| Q _{gd} | Gate Drain Charge | | | 6.5 | | nC |
| t _{D(on)} | Turn-On DelayTime | V _{GS} =10V, V _{DS} =500V, I _D =5A, R _G =25Ω | | 27 | | ns |
| t _r | Turn-On Rise Time | | | 40 | | ns |
| t _{D(off)} | Turn-Off DelayTime | | | 50 | | ns |
| t _f | Turn-Off Fall Time | | | 33 | | ns |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =5A, dI/dt=100A/μs, V _{DS} =100V | 350 | 450 | 550 | ns |
| Q _{rr} | Body Diode Reverse Recovery Charge | I _F =5A, dI/dt=100A/μs, V _{DS} =100V | 4.2 | 5.5 | 6.8 | μC |

A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25°C.

B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

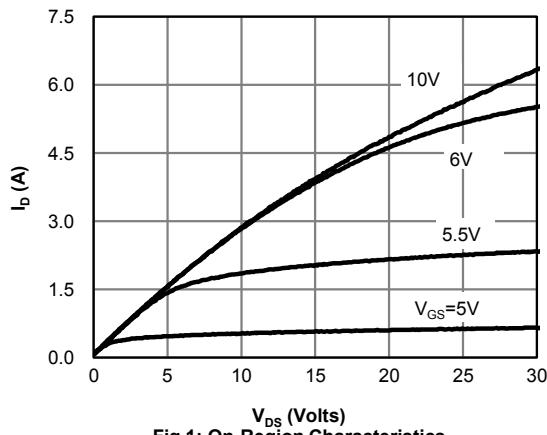
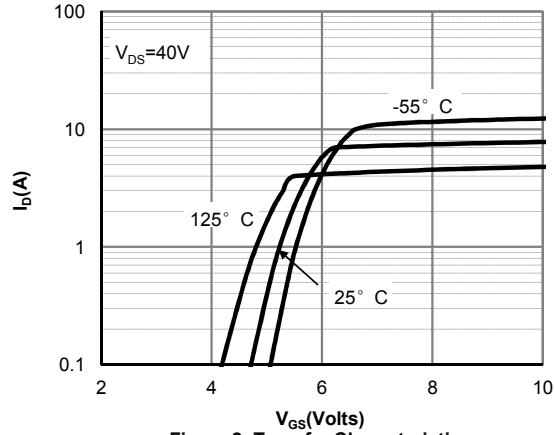
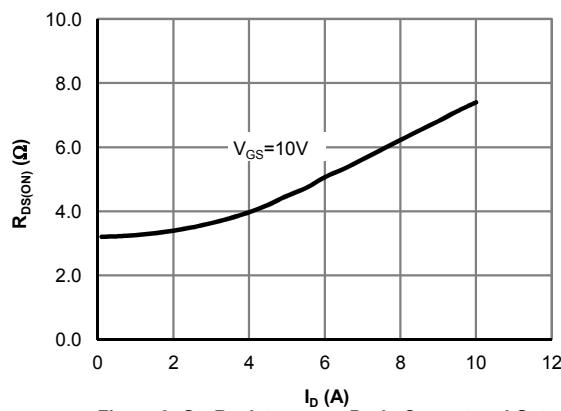
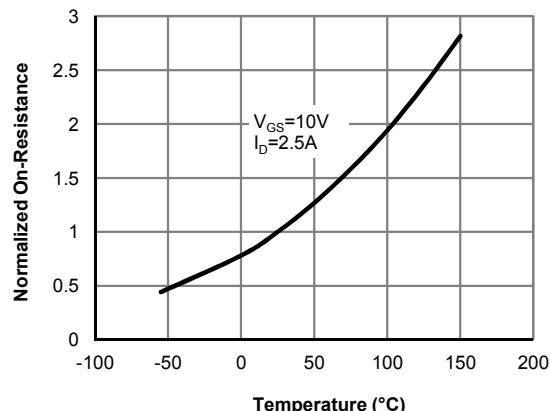
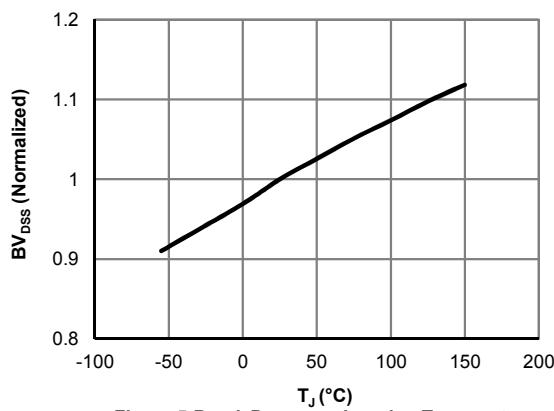
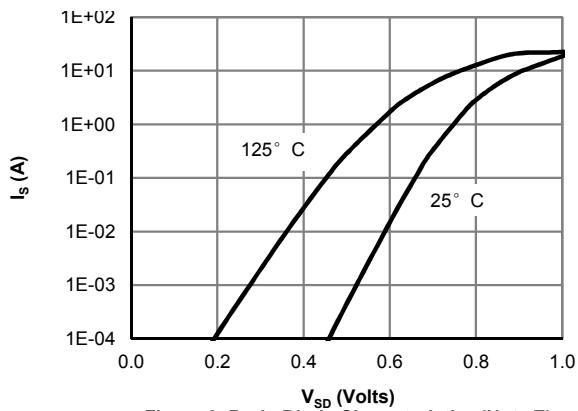
D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

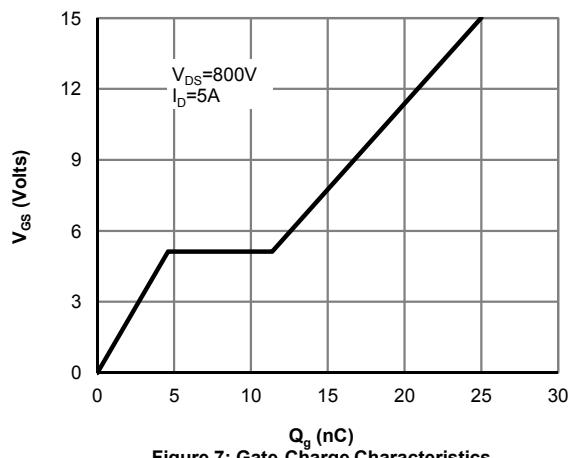
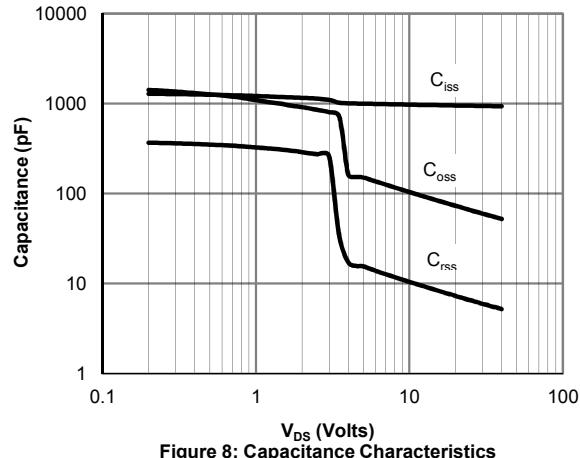
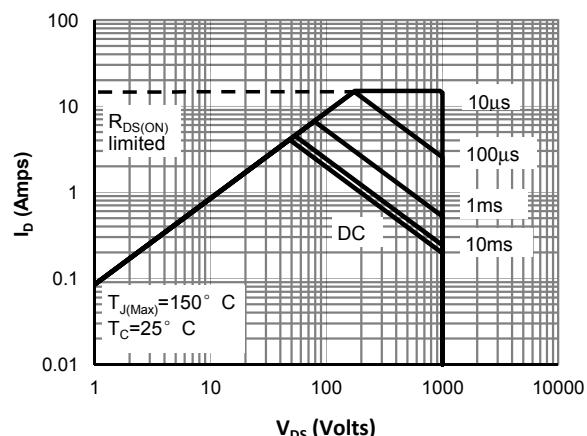
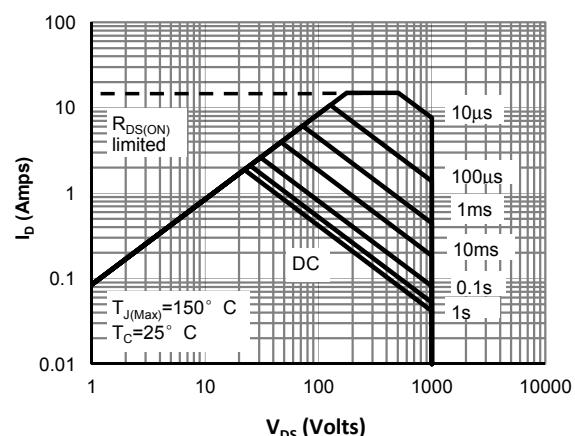
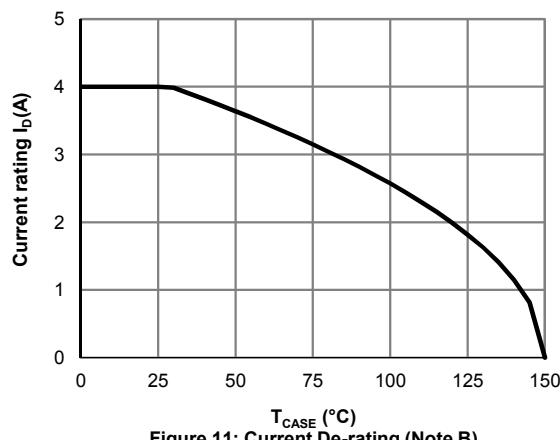
E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150°C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=2.8A, V_{DD}=150V, R_G=25Ω, Starting T_J=25°C

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5:Break Down vs. Junction Temperature

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area for AOT5N100 (Note F)

Figure 10: Maximum Forward Biased Safe Operating Area for AOTF5N100 (Note F)

Figure 11: Current De-rating (Note B)

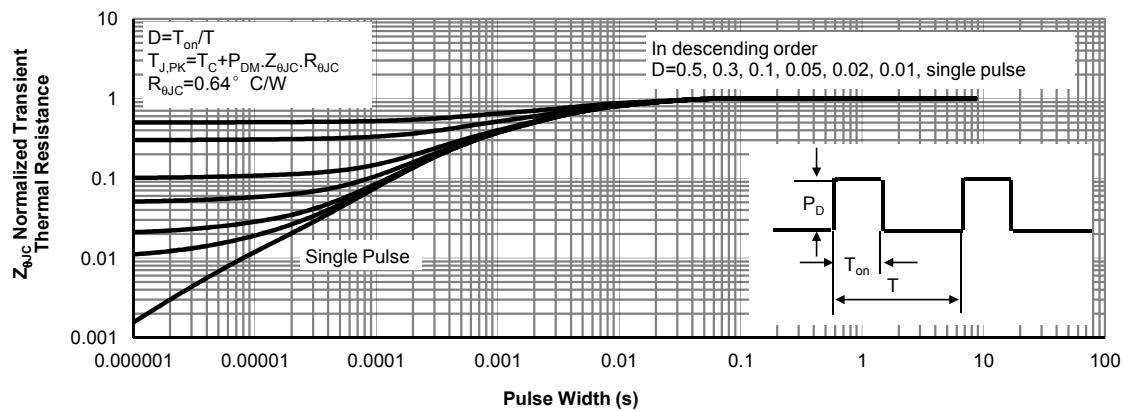
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 12: Normalized Maximum Transient Thermal Impedance for AOT5N100 (Note F)

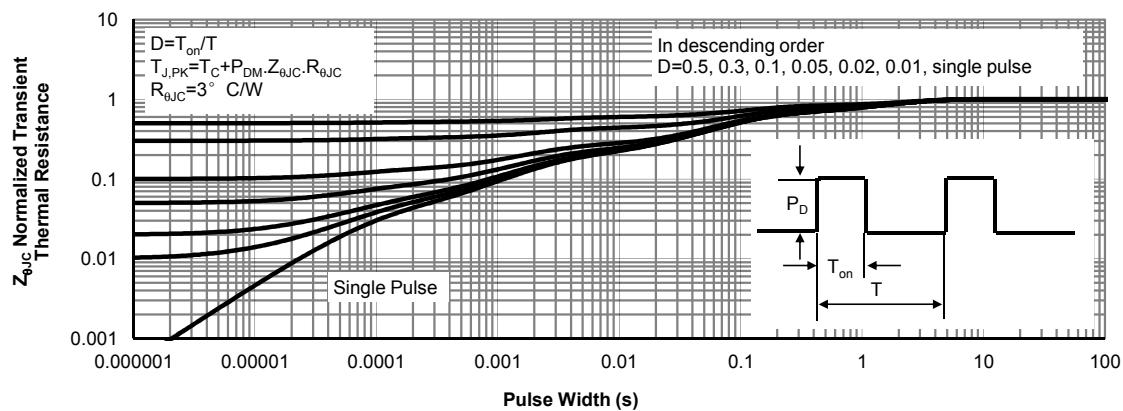
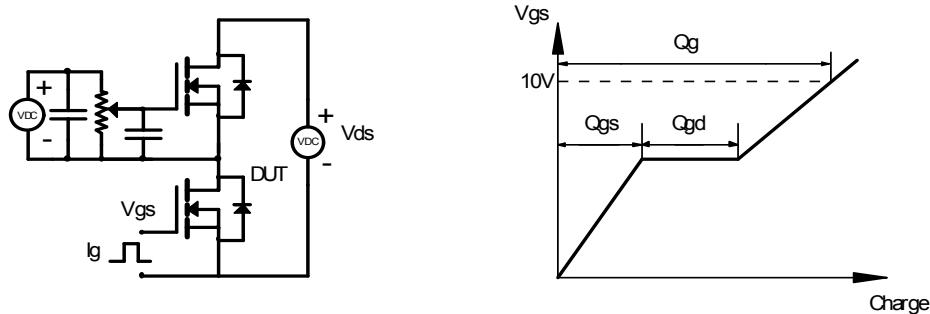


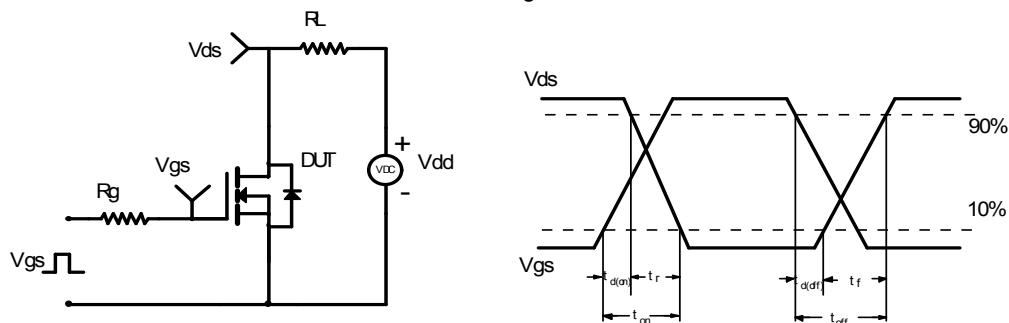
Figure 13: Normalized Maximum Transient Thermal Impedance for AOTF5N100 (Note F)



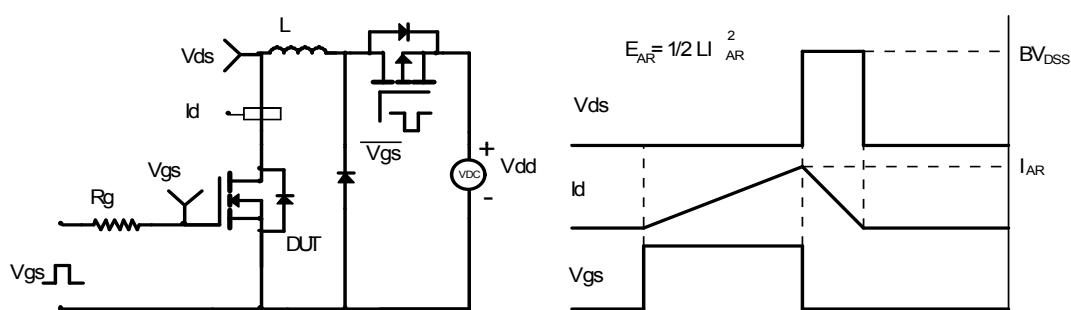
Gate Charge Test Circuit & Waveform



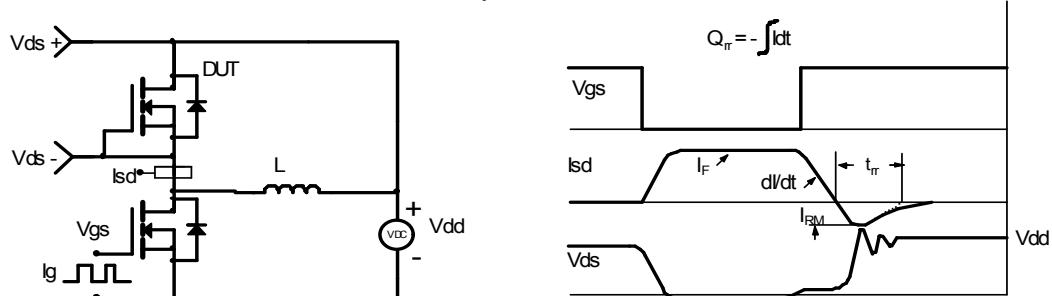
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